SEIKO EPSON CORPORATION

CRYSTAL OSCILLATOR (Programmable) **OUTPUT: CMOS**

SG-8018 series

• Frequency range : 0.67 MHz to 170 MHz (1 ppm Step)

 Supply voltage : 1.62 V to 3.63 V

: Output enable (OE) or Standby (ST) Function

• Frequency tolerance: ±50 ppm (-40 °C to +105 °C)

Including frequency aging(+25 °C, 10 years)

• PLL technology to enable short lead time

• Available field oscillator programmer "SG-Writer II"





Product Number

CB

SG-8018CG: X1G005601xxxx00 SG-8018CE: X1G005591xxxx00 SG-8018CB: X1G005581xxxx00 SG-8018CA: X1G005571xxxx00



 $5.0 \times 3.2 \text{ mm}$ $7.0 \times 5.0 \text{ mm}$

CG CE

 $2.5 \times 2.0 \text{ mm}$ $3.2 \times 2.5 \text{ mm}$

Specifications (characteristics)

Specifica	uons (chara	icienslics)								
Ite	m	Symbol	Specifications		Conditions/Remarks					
Supply voltage		Vcc	1.80	V Typ.	2.50 V Typ.	3.30 V Typ.			_	
			1.62 V to 1.98 V	1.98 V to 2.20 V	2.20 V to 2.80 V	2.70 V to 3.63 V			-	
Output frequen	cy range	f _O		0.67 MHz	to 170 MHz					
Storage tempe		T_stg		-40 °C to	o +125 °C		Storage as single product.			
Operating temp	perature	T_use		-40 °C to	o +105 °C		-			
Frequency tole	rance ^{*1}	f_tol		J: ±50 × 10 ⁻⁶				·105 °C		
			3.2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	No loa	d, f _o = 20 MHz	
Current consur	nntion	Icc	2.7 ı	тА Тур.	2.9 mA Typ.	3.0 mA Typ.	T_use = +25 °C	INO IOA	u, 10 – 20 IVII 12	
Current consu	приоп	ICC	5.5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 °C	No loo	d fo = 170 MHz	
			4.7 ı	тА Тур.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C	INO IOA	No load, f ₀ = 170 MHz	
Output disable	current	I_dis	3.2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, f ₀ = 170) MHz		
Standby currer	.	I std	0.9 µA Max.	1.0 μA Max.	1.5 µA Max.	2.5 µA Max.	T_use = +105 °C	ST = (CND	
Standby currer	ıı	i_siu	0.3 μA Typ.	0.4 μA Typ.	0.5 μA Typ.	1.1 μA Typ.	T_use = +25 °C	31 - 0	סווט	
Symmetry		SYM		45 %	to 55 %		50 % V _{CC} Level			
							I _{OH} /I _{OL} Conditions		[mA]	
				/ .			Rise/Fall time	V _{CC}	*A *B *C *D	
		Vон	90 % V _{CC} Min.			Default (f _O > 40 MHz). Fast		-2.5 -3.5 -4.0 -5.0 2.5 3.5 4.0 5.0		
Output voltage							I _{OL}	2.5 3.5 4.0 5.0 -1.5 -2.0 -2.5 -3.0		
(DC characteris	stics)						TDetault (To < 40 MHz) ⊢	I _{OL}	1.5 2.0 2.5 3.0	
,	(Co characteristics)							Іон	-1.0 -1.5 -2.0 -2.5	
			10 % V _{CC} Max.			loL	1.0 1.5 2.0 2.5			
								98 V, *B: 1.98 V to 2.20 V,		
Output load co	ndition	L CMOS	15 pF Max.				*C: 2.20 V to 2.80 V, *D: 2.70 V to 3.63 V			
<u> </u>		V _{IH}	·						-	
Input voltage			70 % V _{CC} Min.				OE or ST			
		VIL	30 % V _{CC} Max.							
	Default		3.0 ns Max.			f _O > 40 MHz				
Rise time	Boldan	tr/tf	6.0 ns Max.			f _O ≤ 40 MHz 20 % - 80 % V _{CC}				
	Fast	tr/tr	3.0 ns Max.			f _O = 0.67 MHz to 17	O MHz L_CMOS = 15 pF			
	Slow		10.0 ns Max.				f ₀ = 0.67 MHz to 20	MHz	MHz	
Output disable time (OE) tstp_oe tstp_st		1 μs Max.				Measured from the V _{CC}	time O	E or ST pin crosses 30 %		
Output enable time (OE) tsta_oe		1 μs Max.				Measured from the	time O	E pin crosses 70 % V _{CC}		
Output enable time (ST) tsta_st		tsta_st	3 ms Max.				Measured from the time ST pin crosses 70 % V _{CC}			
Start-up time		t_str	3 ms Max.				Measured from the minimum value, 1.6		c reaches its rated	
Frequency agir	ng	f_age	This is included in frequency tolerance specification.				+25 °C, 10 years			

^{*1} Frequency tolerance includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient, frequency / load coefficient and frequency aging (+25 °C, 10 years).

Pin description

Pin	Name	I/O type		Function
OE Input	Output enable	High*2: Specified frequency output from OUT pin		
		Low: Out pin is low (weak pull down), only output driver is disabled.		
1	1 ST Input	Standby	High*2: Specified frequency output from OUT pin	
			Low: Out pin is low (weak pull down),	
		Device goes to standby mode. Supply current reduces to the least as I_std.		
2	GND	Power	Ground	
3	OUT	Output	Clock output	
4	V _{CC}	Power	Power supply	

^{*2} Please do not use the OE/ST terminal in the open state.



Product Name

SG-8018CG 25.000000MHz TJHPA 45678

- 1) Model 2) Package type 3) Frequency
- (4) Supply voltage (T: 1.8 V to 3.3 V Typ.)
- ⑤Frequency tolerance (J: ±50 × 10⁻⁶)
- 6 Operating temperature (H: -40 °C to +105 °C)
- 7 Function 8 Rise/Fall time

②Pa	ckage type
CG	2.5 mm × 2.0 mm
CE	3.2 mm × 2.5 mm
СВ	5.0 mm × 3.2 mm
CA	7.0 mm × 5.0 mm

⑦Function			
P Output enable			
S	Standby		

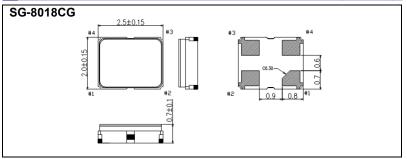
Footprint (Recommended)

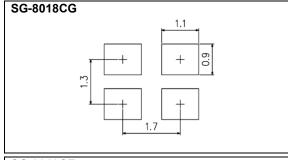
®Rise time/Fall time		
Α	Default	
В	Fast	
C*	Slow	

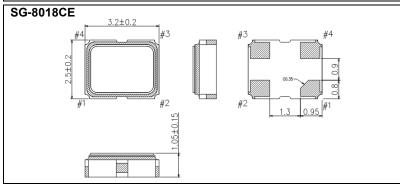
* Available only when fo \leq 20 MHz

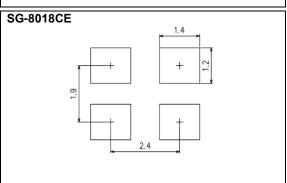
(Unit: mm)

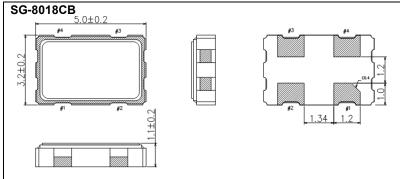
External dimensions (Unit: mm) SG-8018CG

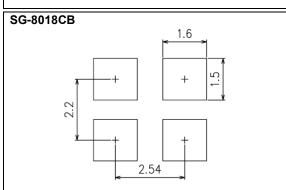


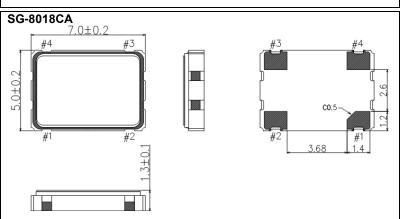


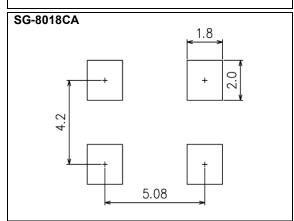












■Notes:

In order to achieve optimum jitter performance, the 0.1 μF capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.





▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

- 1. The content of this document is subject to change without notice. Before purchasing or using Epson products, please contact with sales representative of Seiko Epson Corporation ("Epson") for the latest information and be always sure to check the latest information published on Epson's official web sites and resources.
- 2. This document may not be copied, reproduced, or used for any other purposes, in whole or in part, without Epson's prior consent.
- 3. Information provided in this document including, but not limited to application circuits, programs and usage, is for reference purpose only. Epson makes no guarantees against any infringements or damages to any third parties' intellectual property rights or any other rights resulting from the information. This document does not grant you any licenses, any intellectual property rights or any other rights with respect to Epson products owned by Epson or any third parties.
- 4. Using Epson products, you shall be responsible for safe design in your products; that is, your hardware, software, and/or systems shall be designed enough to prevent any critical harm or damages to life, health or property, even if any malfunction or failure might be caused by Epson products. In designing your products with Epson products, please be sure to check and comply with the latest information regarding Epson products (including, but not limited to this document, specifications, data sheets, manuals, and Epson's web site). Using technical contents such as product data, graphic and chart, and technical information, including programs, algorithms and application circuit examples under this document, you shall evaluate your products thoroughly both in stand-alone basis and within your overall systems. You shall be solely responsible for deciding whether to adopt/use Epson products with your products.
- 5. Epson has prepared this document carefully to be accurate and dependable, but Epson does not guarantee that the information is always accurate and complete. Epson assumes no responsibility for any damages you incurred due to any misinformation in this document.
- 6. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed.
- 7. Epson products have been designed, developed and manufactured to be used in general electronic applications and specifically designated applications ("Anticipated Purpose"). Epson products are NOT intended for any use beyond the Anticipated Purpose that requires particular quality or extremely high reliability in order to refrain from causing any malfunction or failure leading to critical harm to life and health, serious property damage, or severe impact on society, including, but not limited to listed below ("Specific Purpose"). Therefore, you are strongly advised to use Epson products only for the Anticipated Purpose. Should you desire to purchase and use Epson products for Specific Purpose, Epson makes no warranty and disclaims with respect to Epson products, whether express or implied, including without limitation any implied warranty of merchantability or fitness for any Specific Purpose. Please be sure to contact our sales representative in advance, if you desire Epson products for Specific Purpose:

Space equipment (artificial satellites, rockets, etc.)/ Transportation vehicles and their control equipment (automobiles, aircraft, trains, ships, etc.) / Medical equipment/ Relay equipment to be placed on sea floor/ Power station control equipment / Disaster or crime prevention equipment/Traffic control equipment/ Financial equipment

Other applications requiring similar levels of reliability as the above

- 8. Epson products listed in this document and our associated technologies shall not be used in any equipment or systems that laws and regulations in Japan or any other countries prohibit to manufacture, use or sell. Furthermore, Epson products and our associated technologies shall not be used for the purposes of military weapons development (e.g. mass destruction weapons), military use, or any other military applications. If exporting Epson products or our associated technologies, please be sure to comply with the Foreign Exchange and Foreign Trade Control Act in Japan, Export Administration Regulations in the U.S.A (EAR) and other export-related laws and regulations in Japan and any other countries and to follow their required procedures.
- 9. Epson assumes no responsibility for any damages (whether direct or indirect) caused by or in relation with your non-compliance with the terms and conditions in this document or for any damages (whether direct or indirect) incurred by any third party that you give, transfer or assign Epson products.
- 10. For more details or other concerns about this document, please contact our sales representative.
- 11. Company names and product names listed in this document are trademarks or registered trademarks of their respective companies.